



Lextar has been dedicated to developing Micro LED technology and providing innovative solutions that cater to diverse customer needs. Its i-PixelTM series integrates advanced technologies to overcome the technical obstacles that have hindered the commercialization of Micro LED. As a result, customers can enjoy the benefits of ultra-high resolution, excellent contrast, and low power consumption. Lextar's commitment to continuous innovation and excellence has positioned it as a leader in the Micro LED industry.





Semi-packaging Solution

R/G/B Micro LED and Si-IC Wafer (only i-Pixel $^{+TM}$)



DO 75 mm DCD Micke LED Dieplay

PU.75 mm RGB MICRO LED Display

Features:

- The world's smallest Micro LED package
- Ultra fine pitch LED display
- High black surface ratio
- High contrast
- Ultra thin package (< 150 μm)
- Suitable for passive matrix driving current





	Chip Dimension (µm)	40 × 80
	Backplane	РСВ
	Resolution (pixel)	640 × 360
	Brightness (nits)	1000
	Black Surface Ratio (%)	>97 % @ P0.75mm module

P0.78125 mm AM RGB Micro LED Display

Features:

- The world's smallest Micro LED plus Micro IC package
- Active matrix driving in package
- High black surface ratio
- High contrast
- No scan line flicker
- Reduce > 20% power
- 14+2 bits gray scale
- Package thickness <150 µm

PCB-Back Side



Traditional-PM Driving



i-Pixel +TM -AM Driving

Chip Dimension (µm)	13 × 20
Backplane	РСВ
Resolution (pixel)	192 × 216
Brightness (nits)	Ι,000



i-Pi×el+™